### Silicon NPN Epitaxial

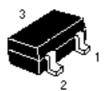
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#### **Application**

UHF frequency converter

#### **Outline**

CMPAK



- 1. Emitter
- 2.Base
- 3. Collector

### Absolute Maximum Ratings ( $Ta = 25^{\circ}C$ )

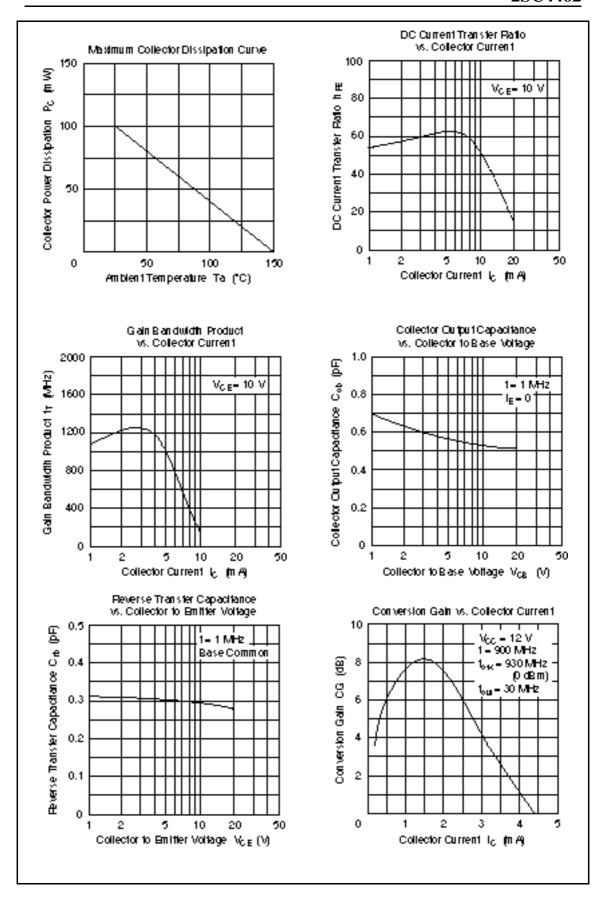
Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	30	V
Collector to emitter voltage	$V_{CEO}$	25	V
Emitter to base voltage	$V_{EBO}$	4	V
Collector current	I <sub>c</sub>	20	mA
Collector power dissipation	P <sub>c</sub>	100	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

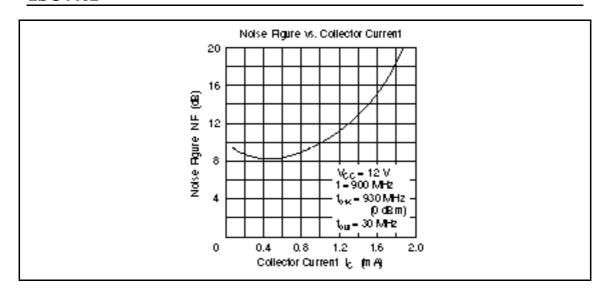


### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

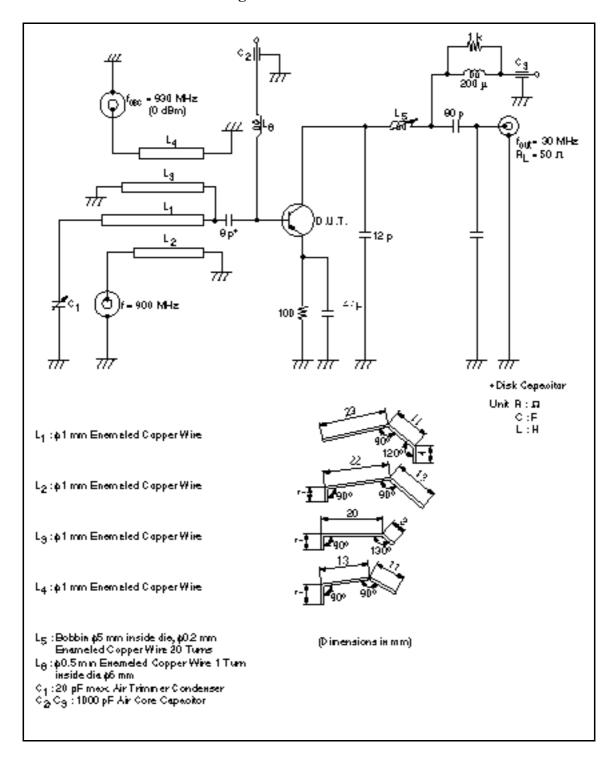
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	_	_	V	$I_{c} = 10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	25	_	_	V	$I_C = 1 \text{ mA}, R_{BE} =$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	4	_	_	V	$I_{E} = 10 \ \mu A, \ I_{C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	0.5	μΑ	$V_{CB} = 10 \text{ V}, I_{E} = 0$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	5	V	$I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 1 \text{ mA}$
DC current transfer ratio	h <sub>FE</sub>	30	_	_		$V_{CE} = 10 \text{ V}, I_{C} = 3 \text{ mA}$
Gain bandwidth product	f <sub>T</sub>	700	1000	_	MHz	$V_{CE} = 10 \text{ V}, I_{C} = 5 \text{ mA}$
Collector output capacitance	Cob	_	_	0.8	pF	$V_{CB} = 10 \text{ V}, I_{C} = 5 \text{ mA},$ f = 1 MHz
Conversion gain	CG		7.0		dB	$V_{CC} = 12 \text{ V}, I_{E} = 0,$ f = 900 MHz
Noise figure	NF	_	10.0	_	dB	$f_{OSC} = 930 \text{ Mhz } (0 \text{ dBm}),$ $f_{out} = 30 \text{ MHz}$

Note: Marking is "EC".





#### **Conversion Gain and Noise Figure Test Circuit**



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